MSE 2001: Exam #3
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March 28th 2012

In taking this test, I agree that I will not participate in cheating or any other forms of academic fraud inconsistent of university policies. I understand that if I am caught participating in these types of actions, my exam grade will immediately default to 0% and I will be unable to retake the exam.

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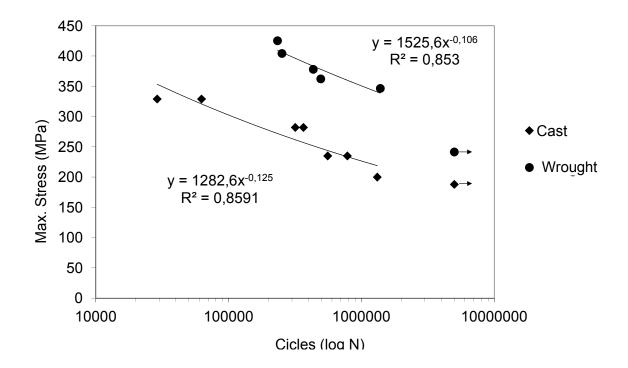
True/False, 21 points (3 point each) (The answer to the following questions are either true or false)
(1)Interstitials typically diffuse slower that substitutionals in the same diffusion media.
(2)The rate of diffusion depends strongly on temperature.
(3)Diffusionless phase transformations often result in a change of composition, but not a change in crystal structure.
(4)In order to achieve precipitation hardening you must be at a temperature in a region of the phase diagram where two phases co-exist.
(5) Castings are typically weaker then their wrought material equivalents.
(6) A functional group in an organic molecule is named so because its function is to remain stable and non-reactive.
(7)To create a thermoset you need at least one of the molecules to have di-functionality.

Conceptual, 39 points (13 points each)

(1) Describe in words only (5 sentences or less) the process of chain growth polymerization.

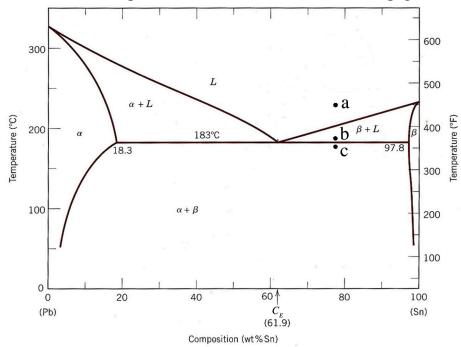
(2) Very small diameter, cold drawn wires have extremely high yield strength. Please describe in the space below why these very small diameter wires have such large yield strength.

(3) This month I received a paper to review about the failure of a total hip implant. They demonstrated that cast materials have much worse fatigue properties than wrought materials (this is taken directly from the paper). They didn't need to submit a paper on this – we already knew this!! Below the graph please explain why the fatigue properties of cast materials are worse than wrought materials.



Quantitative (40 points)

Please use the Pb-Sn diagram above to answer the following questions:



- 1. The eutectic composition of Pb-Sn solder (a substance that is melted and used to join metal ends of wires together) is 61.9% Sn. In one sentence please explain why this composition used?
- 2. When solder is at 100 °C what phases are present and what are the compositions of these phases?

3. What are the fractions of the solder phases present in question 2?